

Features

- Trench LV MOSFET Technology
- Exceptional ON Resistance and Maximum DC Current Capability
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device^(Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

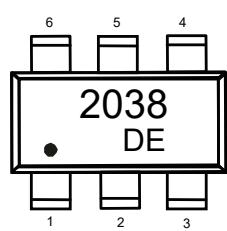
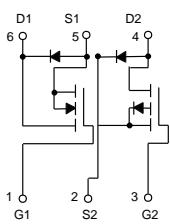
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 120°C/W Junction to Ambient^(Note 2)

| Parameter | Symbol | Rating | Unit |
|---|-----------------|--------|------|
| Total Power Dissipation ^(Note 4) | P _D | 1.05 | W |
| N-Channel MOSFET | | | |
| Drain-Source Voltage | V _{DS} | 20 | V |
| Gate-Source Voltage | V _{GS} | ±10 | V |
| Continuous Drain Current <small>T_A=25°C</small> | I _D | 5 | A |
| | | 3.1 | |
| Pulsed Drain Current ^(Note 3) | I _{DM} | 20 | A |
| P-Channel MOSFET | | | |
| Drain-Source Voltage | V _{DS} | -20 | V |
| Gate-Source Voltage | V _{GS} | ±12 | V |
| Continuous Drain Current <small>T_A=25°C</small> | I _D | -4 | A |
| | | -2.5 | |
| Pulsed Drain Current ^(Note 3) | I _{DM} | -16 | A |

Note:

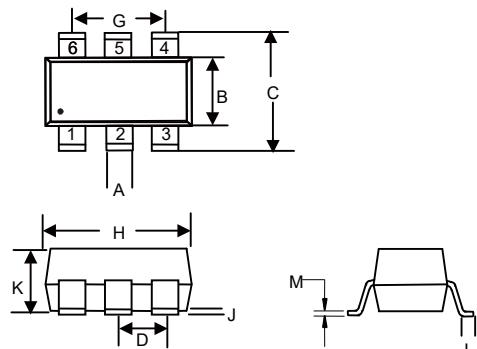
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C.
3. Repetitive rating; pulse width limited by max. junction temperature.
4. P_D is based on max. junction temperature, using junction-ambient thermal resistance.

Internal Structure and Marking Code



Dual N&P-Channel MOSFET

SOT23-6L



| DIM | DIMENSIONS | | | | NOTE |
|-----|------------|-------|------|------|------|
| | INCHES | | MM | | |
| | MIN | MAX | MIN | MAX | |
| A | 0.012 | 0.020 | 0.30 | 0.50 | |
| B | 0.051 | 0.070 | 1.30 | 1.80 | |
| C | 0.087 | 0.126 | 2.20 | 3.20 | |
| D | 0.037 | | 0.95 | | TYP. |
| G | 0.074 | | 1.90 | | TYP. |
| H | 0.106 | 0.122 | 2.70 | 3.10 | |
| J | 0.002 | 0.006 | 0.05 | 0.15 | |
| K | 0.030 | 0.051 | 0.75 | 1.30 | |
| L | 0.012 | 0.024 | 0.30 | 0.60 | |
| M | 0.003 | 0.008 | 0.08 | 0.22 | |

N-Channel ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)

| Parameter | Symbol | Test conditions | Min | Typ | Max | Unit |
|---------------------------------|----------------------|---|-----|-----|------|------|
| Static Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | V _{GS} =0V, I _D =250μA | 20 | | | V |
| Gate-Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} , I _D =250μA | 0.5 | 0.7 | 1 | V |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±12V, V _{DS} =0V | | | ±100 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =20V, V _{GS} =0V | | | 1 | μA |
| Drain-Source On-Resistance | R _{DS(on)} | V _{GS} =4.5V, I _D =4.5A | | 18 | 25 | mΩ |
| | | V _{GS} =2.5V, I _D =3A | | 23 | 32 | |
| | | V _{GS} =1.8V, I _D =2A | | 30 | 49 | |
| Forward Transconductance | g _{FS} | V _{DS} =5V, I _D =4A | | 21 | | s |
| Gate Resistance | R _g | f=1 MHz, Open drain | | 2.3 | | Ω |
| Diode Characteristics | | | | | | |
| Continuous Body Diode Current | I _S | | | | 5 | A |
| Diode Forward Voltage | V _{SD} | V _{GS} =0V, I _S =1.7A | | | 1.3 | V |
| Reverse Recovery Time | t _{rr} | I _F =4A, dI _F /dt=100A/μs | | 12 | | ns |
| Reverse Recovery Charge | Q _{rr} | | | 3.6 | | nC |
| Dynamic Characteristics | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} =10V, V _{GS} =0V, f=1MHz | | 386 | | pF |
| Output Capacitance | C _{oss} | | | 71 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 62 | | |
| Total Gate Charge | Q _g | V _{DS} =10V, V _{GS} =4.5V, I _D =4A | | 5.4 | | nC |
| Gate-Source Charge | Q _{gs} | | | 0.6 | | |
| Gate-Drain Charge | Q _{gd} | | | 1.5 | | |
| Turn-On Delay Time | t _{d(on)} | V _{DD} =10V, V _{GS} =4.5V, R _G =3Ω, I _D =4A | | 5 | | ns |
| Turn-On Rise Time | t _r | | | 7 | | |
| Turn-Off Delay Time | t _{d(off)} | | | 16 | | |
| Turn-Off Fall Time | t _f | | | 5 | | |

P-Channel ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)

| Parameter | Symbol | Test conditions | Min | Typ | Max | Unit |
|---------------------------------|----------------------|--|------|------|------|------|
| Static Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | V _{GS} =0V, I _D =-250μA | -20 | | | V |
| Gate-Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} , I _D =-250μA | -0.5 | -0.7 | -1 | V |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±12V, V _{DS} =0V | | | ±100 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =-16V, V _{GS} =0V | | | -1 | μA |
| Drain-Source On-Resistance | R _{DS(on)} | V _{GS} =-4.5V, I _D =-3.5A | | 49 | 64 | mΩ |
| | | V _{GS} =-2.5V, I _D =-3A | | 64 | 80 | |
| | | V _{GS} =-1.8V, I _D =-2A | | 90 | 110 | |
| Forward Transconductance | g _{FS} | V _{DS} =-5V, I _D =-2.3A | | 10 | | S |
| Gate Resistance | R _g | f=1 MHz, Open drain | | 14 | | Ω |
| Diode Characteristics | | | | | | |
| Continuous Body Diode Current | I _S | | | | -4 | A |
| Diode Forward Voltage | V _{SD} | V _{GS} =0V, I _S =-1.25A | | | -1.3 | V |
| Reverse Recovery Time | t _{rr} | I _F =-1.4A, dI _F /dt=100A/μs | | 16 | | ns |
| Reverse Recovery Charge | Q _{rr} | | | 4.7 | | nC |
| Dynamic Characteristics | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} =-10V, V _{GS} =0V, f=1MHz | | 490 | | pF |
| Output Capacitance | C _{oss} | | | 69 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 58 | | |
| Total Gate Charge | Q _g | V _{DS} =-10V, V _{GS} =-4.5V, I _D =-2.3A | | 5.8 | | nC |
| Gate-Source Charge | Q _{gs} | | | 1.4 | | |
| Gate-Drain Charge | Q _{gd} | | | 1.2 | | |
| Turn-On Delay Time | t _{d(on)} | V _{DD} =-10V, V _{GS} =-4.5V, R _G =6Ω, I _D =-1.4A | | 8 | | ns |
| Turn-On Rise Time | t _r | | | 9 | | |
| Turn-Off Delay Time | t _{d(off)} | | | 26 | | |
| Turn-Off Fall Time | t _f | | | 26 | | |

Curve Characteristics(N-Channel)

Fig.1 - Typical Output Characteristics

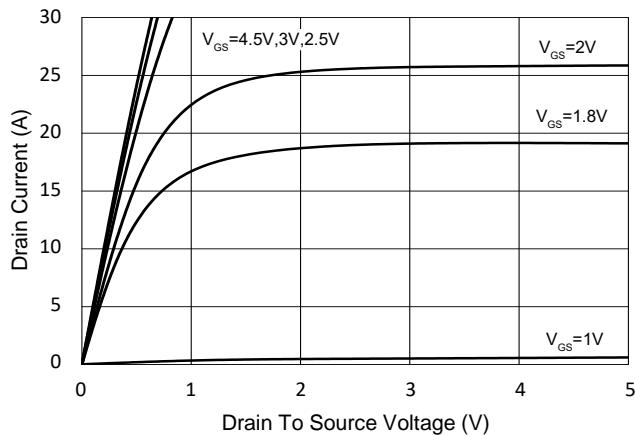


Fig.2 - Transfer Characteristic

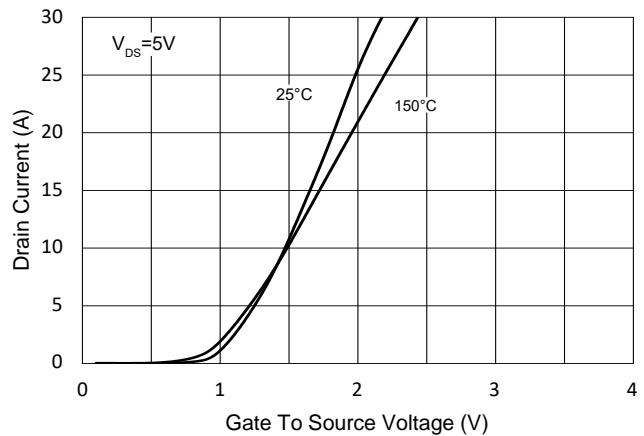


Fig.3 - $R_{DS(ON)}$ - V_{GS}

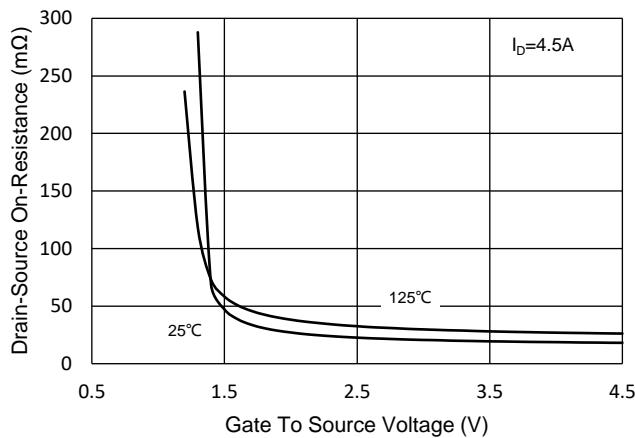


Fig.4 - $R_{DS(ON)}$ - I_D

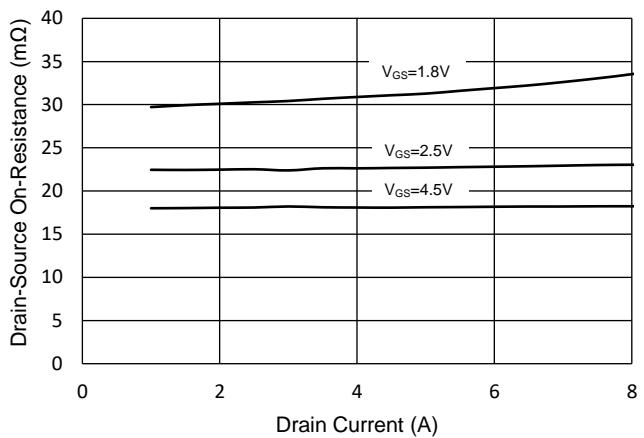


Fig.5 - Capacitance Characteristics

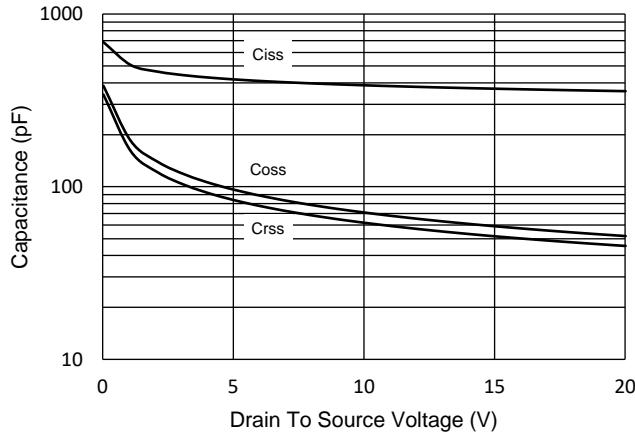
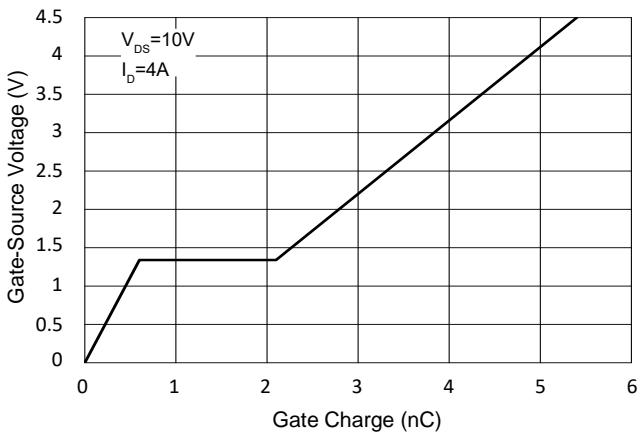


Fig.6 - Gate Charge



Curve Characteristics(N-Channel)

Fig.7 - Normalized Threshold Voltage

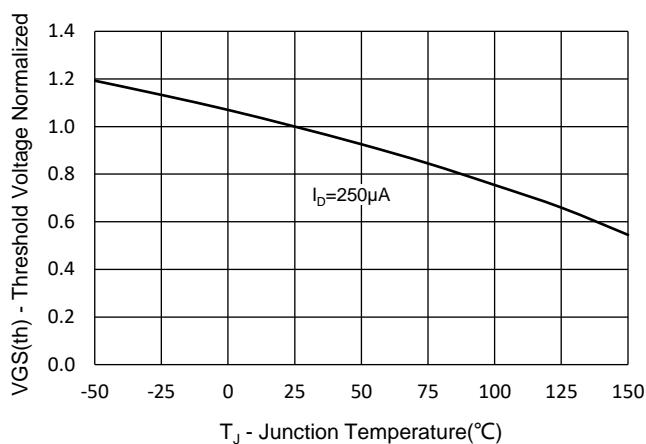


Fig.8 - Normalized On Resistance Characteristics

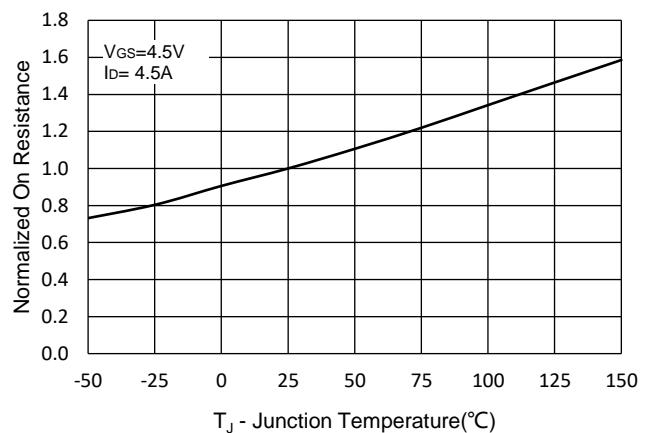


Fig.9 - I_S - V_{SD}

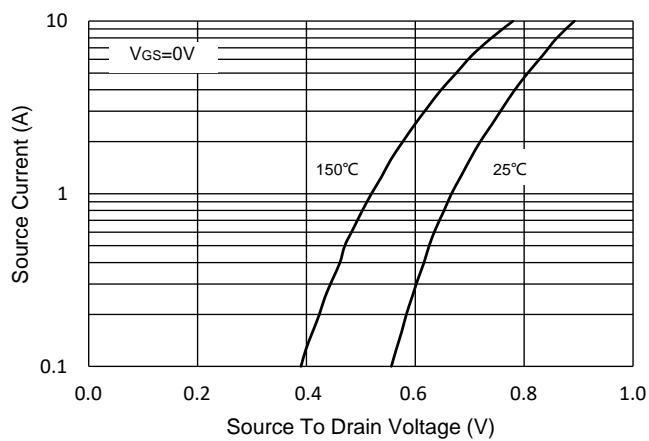


Fig.10 - Drain Current

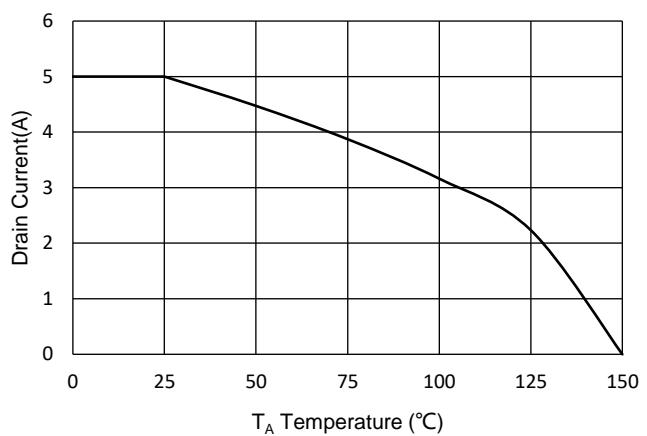
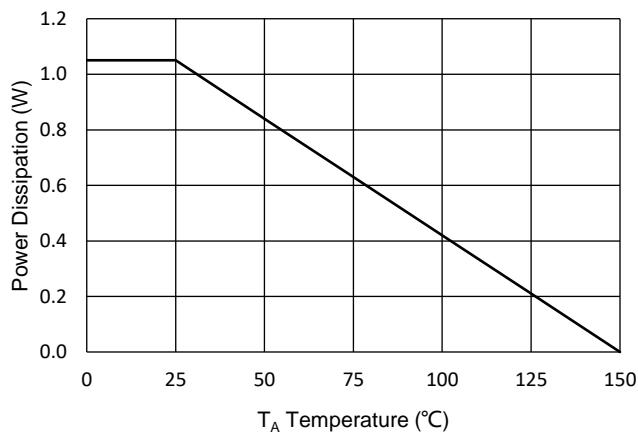


Fig.11 - PD Dissipation



Curve Characteristics(N-Channel)

Fig.12 - Safe Operation Area

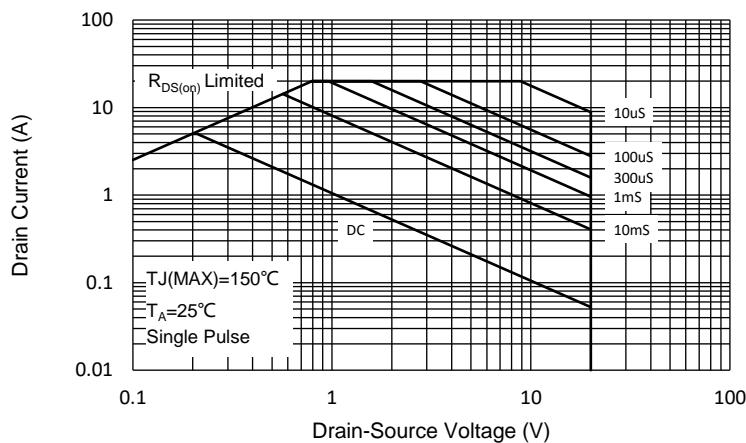
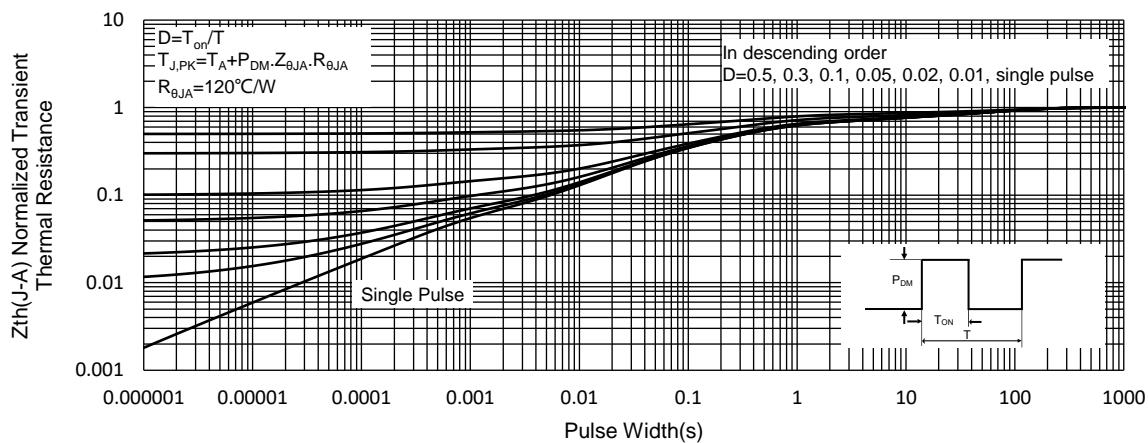


Fig.13 - Normalized Transient Thermal Impedance



Curve Characteristics(P-Channel)

Fig.1 - Typical Output Characteristics

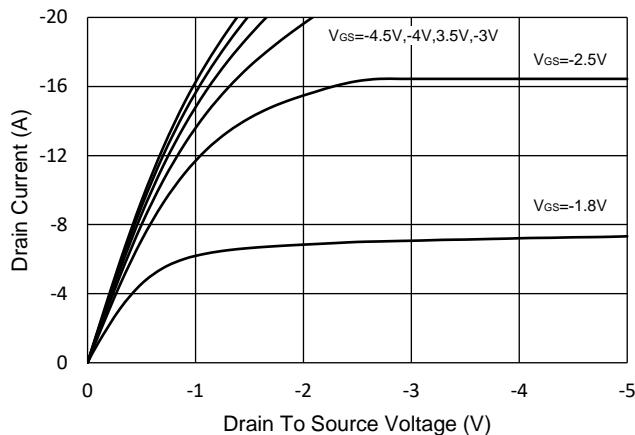


Fig.2 - Transfer Characteristic

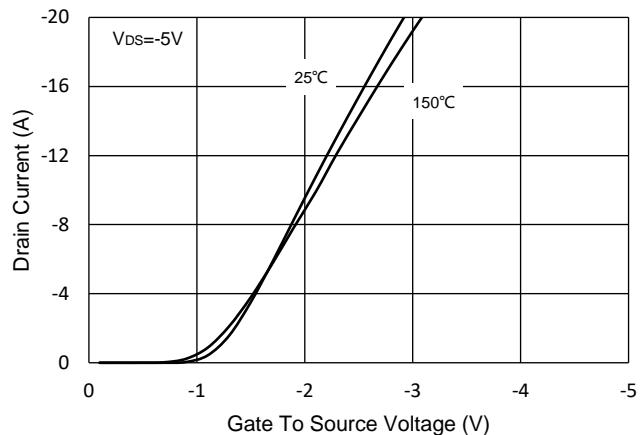


Fig.3 - $R_{DS(ON)}$ - V_{GS}

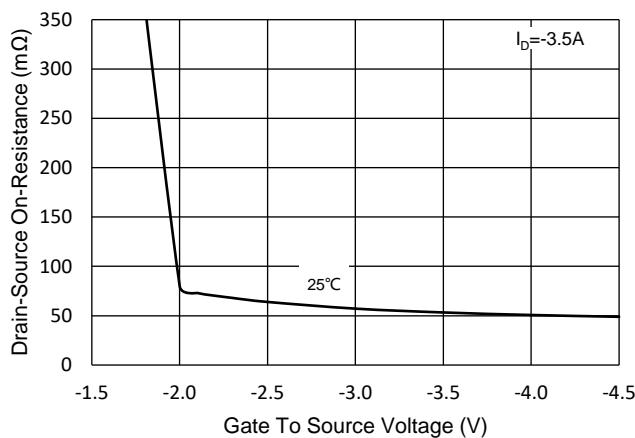


Fig.4 - $R_{DS(ON)}$ - I_D

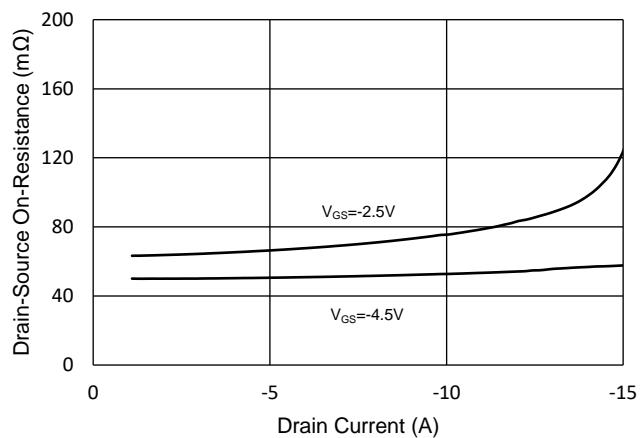


Fig.5 - Capacitance Characteristics

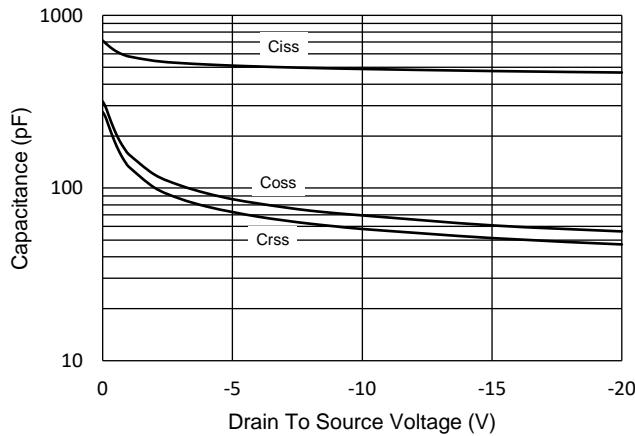
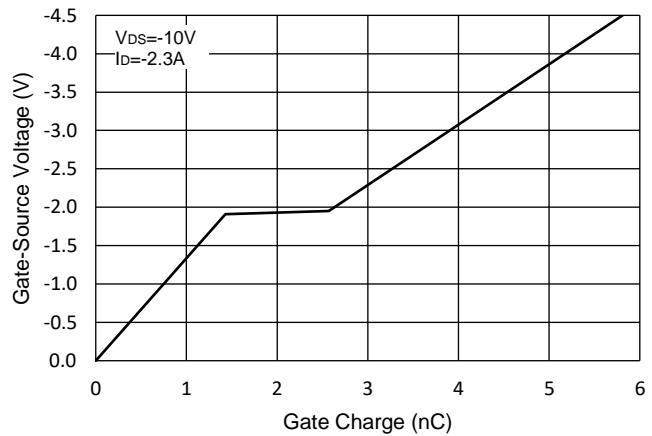


Fig.6 - Gate Charge



Curve Characteristics(P-Channel)

Fig.7 - Normalized Threshold Voltage

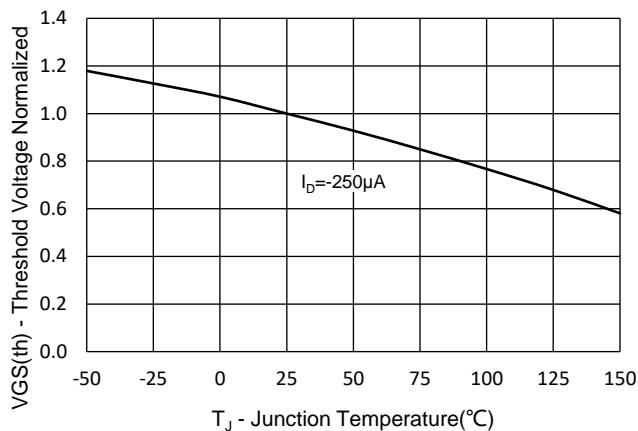


Fig.8 - Normalized On Resistance Characteristics

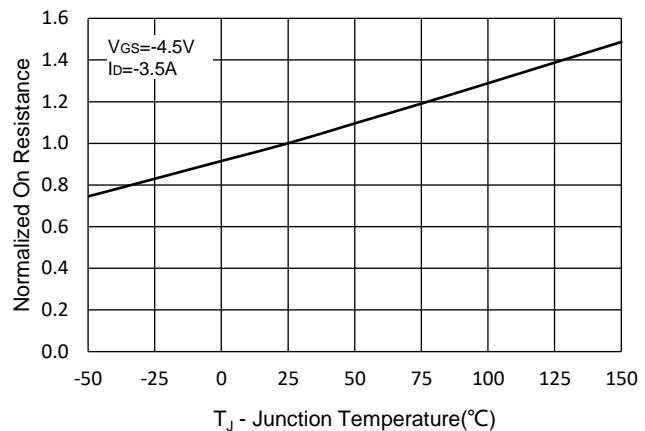


Fig.9 - I_S - V_{SD}

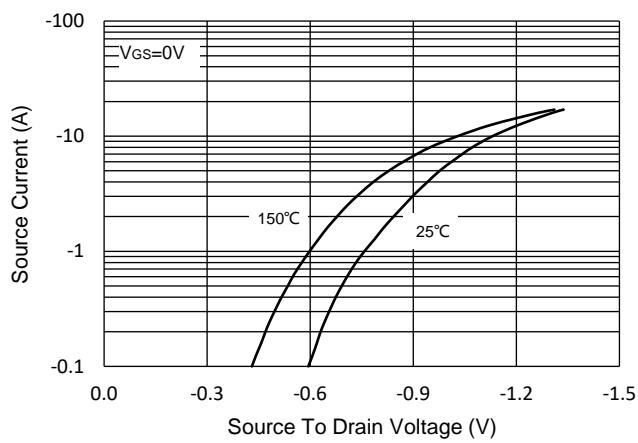


Fig.10 - Drain Current

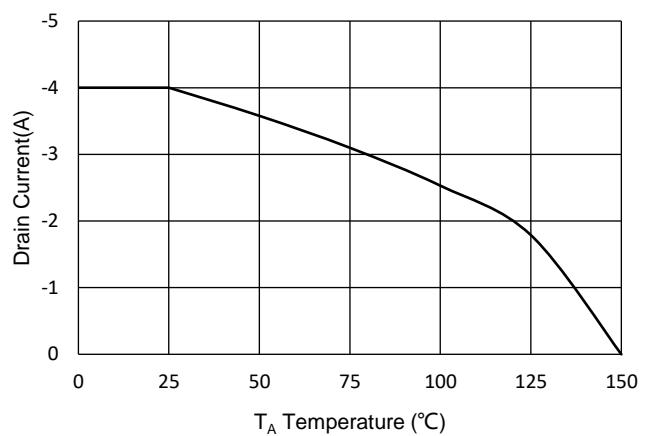
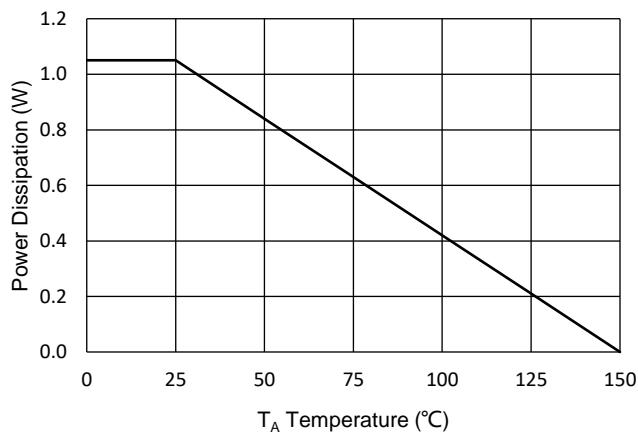


Fig.11 - PD Dissipation



Curve Characteristics(P-Channel)

Fig.12 - Safe Operation Area

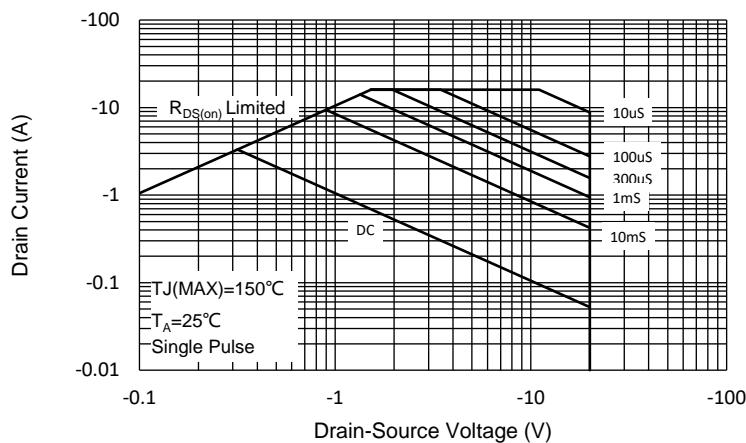
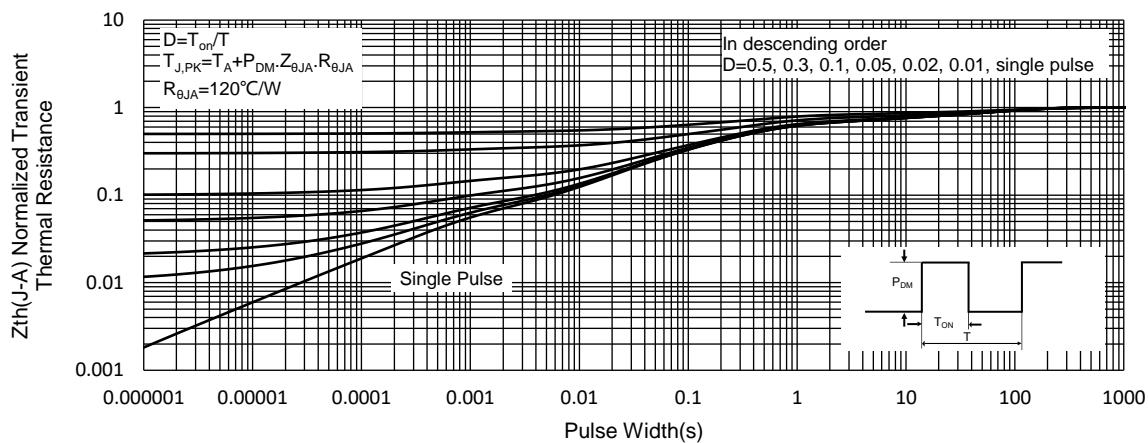


Fig.13 - Normalized Transient Thermal Impedance



Ordering Information

| Device | Packing |
|----------------|-----------------------|
| Part Number-TP | Tape&Reel: 3Kpcs/Reel |

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